To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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RENESAS

DATA SHEET

SILICON POWER MOS FET
NE5531079A

7.5 V OPERATION SILICON RF POWER LDMOS FET FOR UHF-BAND 10 W TRANSMISSION AMPLIFIERS

DESCRIPTION

The NE5531079A is an N-channel silicon power laterally diffused MOS FET specially designed as the transmission power amplifier for 7.5 V radio systems. Dies are manufactured using our NEWMOS-M1 technology and housed in a surface mount package. This device can deliver 40.0 dBm output power with 68% power added efficiency at 460 MHz under the 7.5 V supply voltage.

FEATURES

- High output power : P_{out} = 40.0 dBm TYP. (V_{DS} = 7.5 V, I_{Dset} = 200 mA, f = 460 MHz, P_{in} = 25 dBm)
- High power added efficiency : η_{add} = 68% TYP. (V_{DS} = 7.5 V, I_{Dset} = 200 mA, f = 460 MHz, P_{in} = 25 dBm)
- High linear gain : G_L = 20.5 dB TYP. (V_{DS} = 7.5 V, I_{Dset} = 200 mA, f = 460 MHz, P_{in} = 10 dBm)
- Surface mount package : 5.7 × 5.7 × 1.1 mm MAX.
- Single supply : V_{DS} = 7.5 V MAX.

APPLICATIONS

- 460 MHz band radio systems
- 900 MHz band radio systems

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
NE5531079A	NE5531079A-A	79A (Pb-Free)	W5	• 12 mm wide embossed taping • Gate pin face the perforation side of the tape
NE5531079A-T1	NE5531079A-T1-A			• 12 mm wide embossed taping • Gate pin face the perforation side of the tape • Qty 1 kpcs/reel
NE5531079A-T1A	NE5531079A-T1A-A			• 12 mm wide embossed taping • Gate pin face the perforation side of the tape • Qty 5 kpcs/reel

Remark To order evaluation samples, please contact your nearby sales office.
Part number for sample order: NE5531079A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.

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Date Published April 2009 NS
Printed in Japan

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ABSOLUTE MAXIMUM RATINGS (T_A = +25°C)

Operation in excess of any one of these parameters may result in permanent damage.

Parameter	Symbol	Ratings	Unit
Drain to Source Voltage	V_{DS} Note 1	30	V
Gate to Source Voltage	V_{GS}	6.0	V
Drain Current	I_{DS}	3.0	A
Drain Current (Pulse Test)	I_{DS} Note 2	6.0	A
Total Power Dissipation	P_{tot}	35	W
Channel Temperature	T_{ch}	125	°C
Storage Temperature	T_{stg}	–55 to +125	°C

Note 1. V_{DS} will be used under 12 V on RF operation.

2. Duty Cycle ≤ 50%, T_{on} ≤ 1 s

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Drain to Source Voltage	V_{DS}		–	6.0	7.5	V
Gate to Source Voltage	V_{GS}		1.15	1.55	2.05	V
Drain Current	I_{DS}		–	2.0	–	A
Input Power	P_{in}	f = 460 MHz, V_{DS} = 6.0 V	–	25	30	dBm

ELECTRICAL CHARACTERISTICS

(T_A = +25°C, unless otherwise specified, using our standard test fixture)

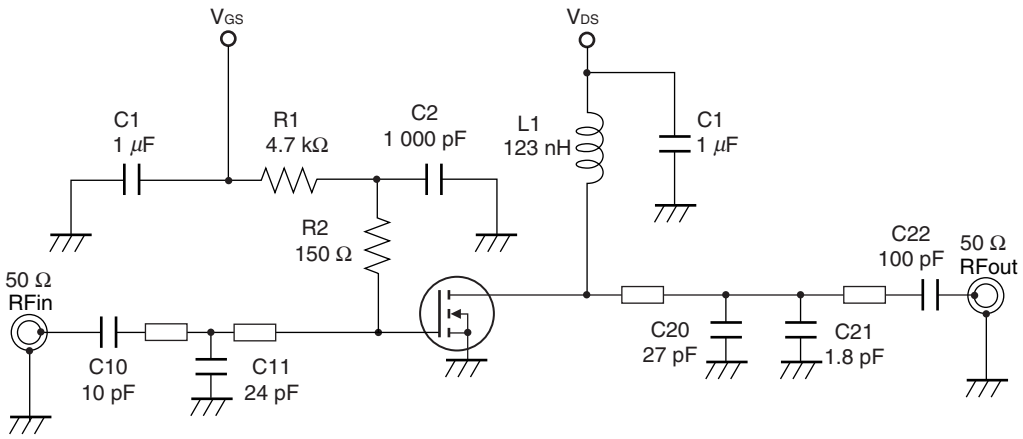
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Gate to Source Leakage Current	I_{GSS}	V_{GS} = 6.0 V	–	–	100	nA
Drain to Source Leakage Current (Zero Gate Voltage Drain Current)	I_{DSS}	V_{DS} = 25 V	–	–	10	nA
Gate Threshold Voltage	V_{th}	V_{DS} = 7.5 V, I_{DS} = 1.0 mA	0.8	1.15	1.55	V
Thermal Resistance	R_{th}	Channel to Case	–	2.9	–	°C/W
Transconductance	g_m	V_{DS} = 7.5 V, I_{DS} = 700±100 mA	2.5	3.2	4.0	S
Drain to Source Breakdown Voltage	BV_{DSS}	I_{DSS} = 10 μA	25	35	–	V
Output Power	P_{out}	f = 460 MHz, V_{DS} = 7.5 V,	39.0	40.0	–	dBm
Drain Current	I_{DS}	P_{in} = 25 dBm,	–	2.0	–	A
Power Added Efficiency	η_{add}	I_{Dset} = 200 mA (RF OFF)	–	68	–	%
Linear Gain	G_L Note		–	20.5	–	dB

Note P_{in} = 10 dBm

DC performance is 100% testing. RF performance is testing several samples per wafer.

Wafer rejection criteria for standard devices is 1 reject for several samples.

TEST CIRCUIT (f = 460 MHz)

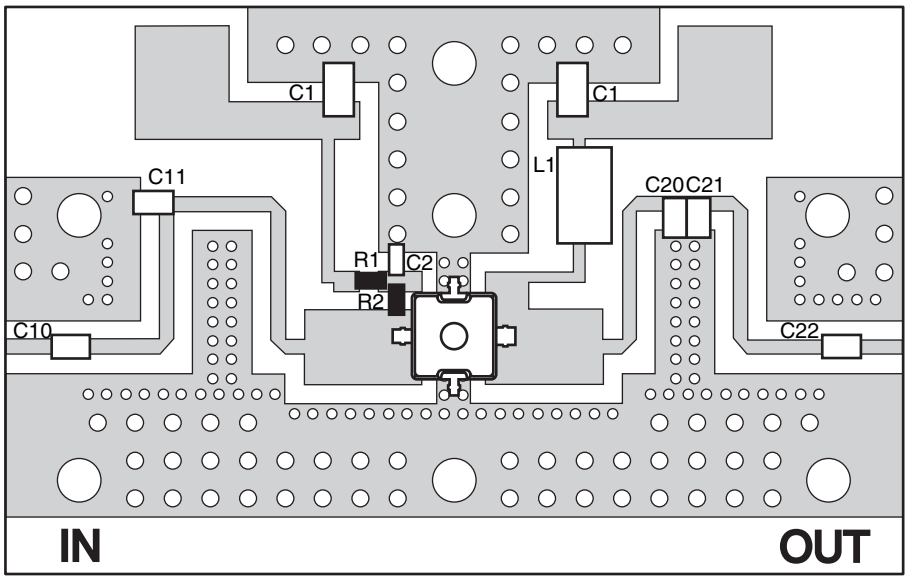


The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

COMPONENTS OF TEST CIRCUIT FOR MEASURING ELECTRICAL CHARACTERISTICS

Symbol	Value	Type	Maker
C1	1 μF	GRM31CR72A105KA01B	Murata
C2	1 000 pF	GRM1882C1H102JA01	Murata
C10	10 pF	GRM1882C1H100JA01	Murata
C11	24 pF	ATC100A240JW	American Technical Ceramics
C20	27 pF	ATC100A270JW	American Technical Ceramics
C21	1.8 pF	ATC100A1R8BW	American Technical Ceramics
C22	100 pF	ATC100A101JW	American Technical Ceramics
R1	4.7 kΩ	1/8W Chip Resistor	–
R2	150 Ω	1/8W Chip Resistor	–
L1	123 nH	φ0.5 mm, φD = 3 mm, 10 Turns	Ohesangyou
PCB	–	R4775, t = 0.4 mm, εr = 4.5, size = 30 × 48 mm	–

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

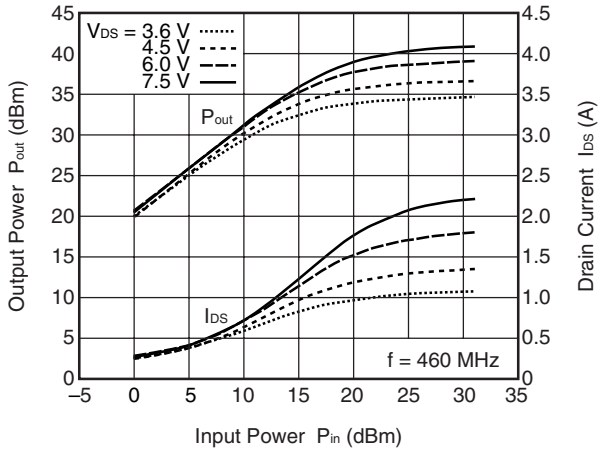


USING THE NEC EVALUATION BOARD

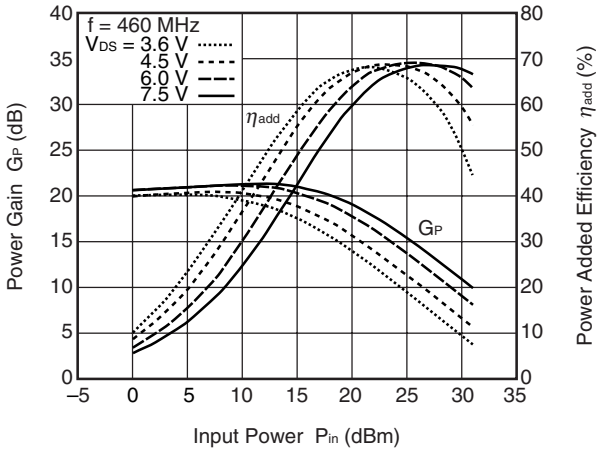
Symbol	Value
C1	1 μF
C2	1 000 pF
C10	10 pF
C11	24 pF
C20	27 pF
C21	1.8 pF
C22	100 pF
R1	4.7 kΩ
R2	150 Ω
L1	123 nH

TYPICAL CHARACTERISTICS (T_A = +25°C, ID_{set} = 200 mA, unless otherwise specified)

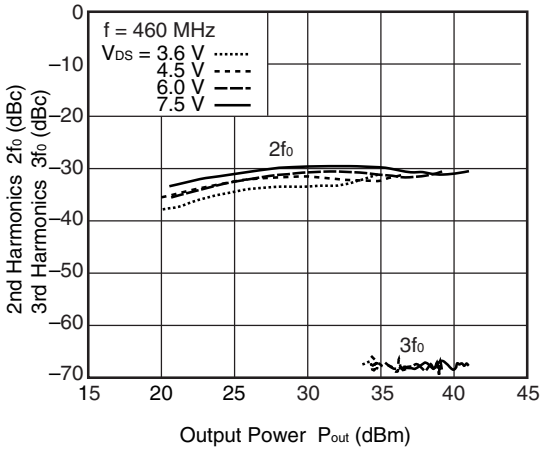
OUTPUT POWER, DRAIN CURRENT vs. INPUT POWER



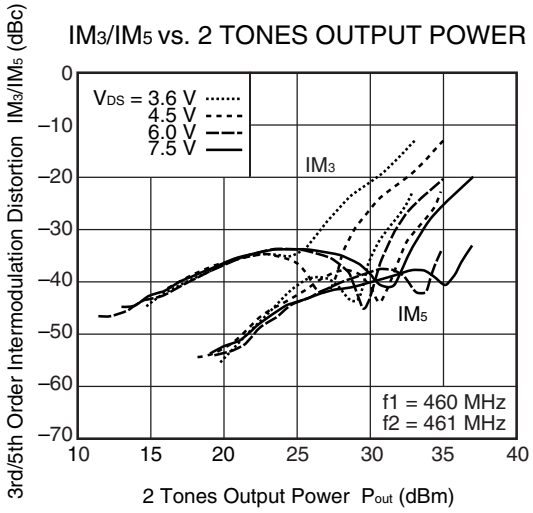
POWER GAIN, POWER ADDED EFFICIENCY vs. INPUT POWER



2f0, 3f0 vs. OUTPUT POWER



IM3/IM5 vs. 2 TONES OUTPUT POWER



Remark The graphs indicate nominal characteristics.

S-PARAMETERS

S-parameters and noise parameters are provided on our Web site in a format (S2P) that enables the direct import of the parameters to microwave circuit simulators without the need for keyboard inputs.

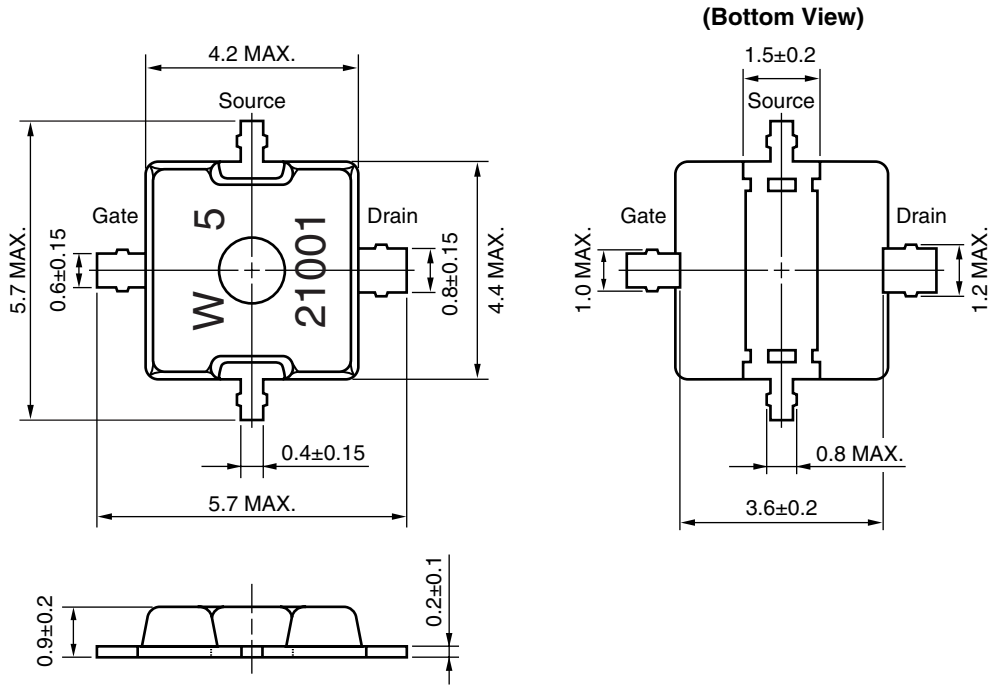
Click here to download S-parameters.

[RF and Microwave] → [Device Parameters]

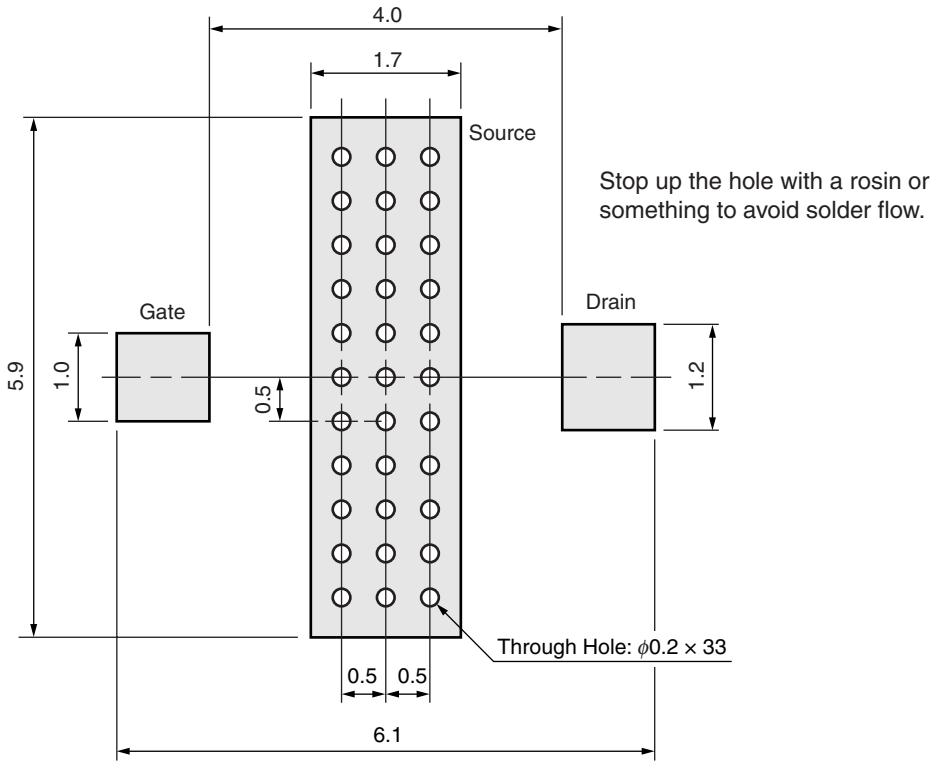
URL http://www.necel.com/microwave/en/

PACKAGE DIMENSIONS

79A (UNIT: mm)



79A PACKAGE RECOMMENDED P.C.B. LAYOUT (UNIT: mm)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (pin temperature) Soldering time (per pin of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350-P3

Caution Do not use different soldering methods together (except for partial heating).

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